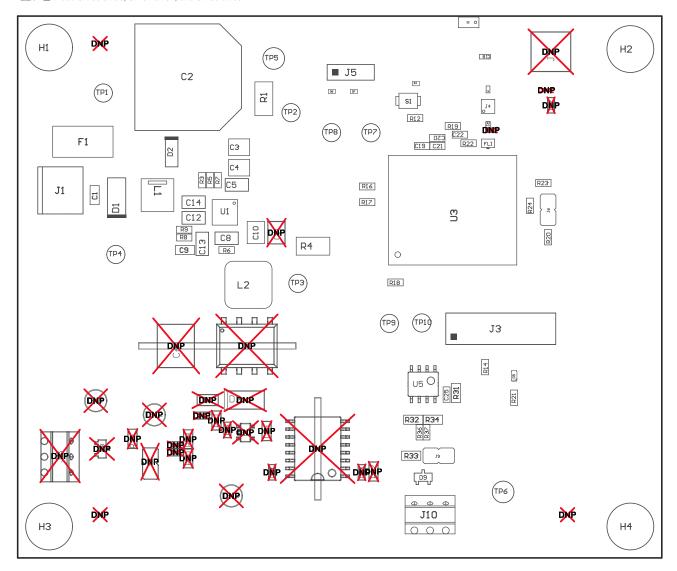
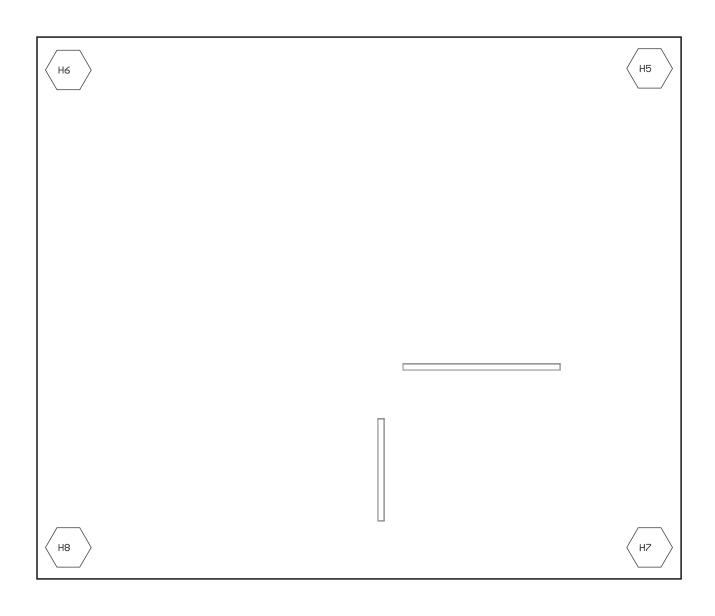
- ZZ1 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ2 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ3 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
- ZZ4 Place SH-J6 on J6, SH-J7 on J7, and SH-J9 on J9



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 002

PCB VIEWED FROM TOP SIDE	BOARD #: ISE4037	REV: E3	SUN REU:	Not In VersionControl
	TID #: TIDA-00485			
PLOT NAME = Top Assembly Drawing	GENERATED : 6/16/2	2:03:48	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 002

PCB VIEWED FROM BOTTOM SIDE	BOARD #: ISE4037	REV: E3	SVN REV: Not In VersionControl
	TID #: TIDA-00485		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/16/2	2:03:53	PM TEXAS INSTRUMENTS

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